KS201

Switch, SP8T
0.02–4.0 GHz

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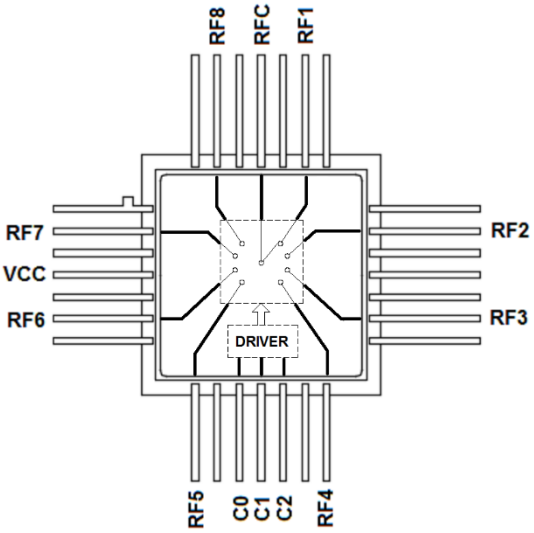
DESCRIPTION

The KS201 is a GaAs pHEMT broadband switch with TTL control in a 28 lead hermetic Surface-Mount Technology (SMT) package for high reliability applications. This switch offers low insertion loss and high isolation with good match in both the insertion loss and isolation states. It can be supplied and tested to the screening requirements of MIL-PRF-38534 Class H and K in addition to the required QCI.



FEATURES

- ✓ Low Insertion Loss: 1.2 dB @ 2 GHz.
- ✓ High Isolation: 42 dB @ 2 GHz.
- ✓ Non-Reflective Match in off state (S22).
- ✓ NASA EEE-INST-002 compliant.
- ✓ High Reliability Class H and K Screening Available.
- ✓ Class K device: 300K RAD Tolerance
- ✓ See Page 5 for MR HI –REL Ordering Details.

APPLICATIONS

- ✓ Space transponders
- ✓ Military Radios
- ✓ Telecom Infrastructure
- ✓ Test Equipment

ELECTRICAL CHARACTERISTICS (-40 to 85˚C)[1]

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Insertion Loss	IL	0.02 – 1.0 GHz		1.2	1.6	dB
		1.0 – 2.0 GHz		1.4	1.8	dB
		2.0 – 3.2 GHz		1.5	2.0	dB
		3.2 – 4.0 GHz		2.0	2.5	dB
Isolation	ISO	0.02 – 1.0 GHz	43	48		dB
		1.0 – 2.0 GHz	37	42		dB
		2.0 – 3.2 GHz	35	39		dB
		3.2 – 4.0 GHz	30	33		dB
Return Loss	|S11|/	0.02 – 1.0 GHz	14	18		dB
Input (All States)	|S22|	1.0 – 3.2 GHz	12	15		dB
Output (ON State)		3.2 – 4.0 GHz	8	10		dB
Return Loss	|S22|	0.30 – 0.7 GHz	5	8		dB
Output (OFF State)		0.7 – 3.2 GHz	12	15		dB
		3.2 – 4.0 GHz	10	12		dB

1. All electrical characteristics are measured at +25˚C at a minimum.

KCB Solutions, LLC
900 Mount Laurel, Shirley, MA 01464
Office: (978) 425-0400

info@kcbsolutions.com
ww.kcbsolutions.com
KS201DS Rev (-1)

OPERATING CHARACTERISTICS (-40 TO +85˚C)[1]

Parameter	Symbol	Conditions	Min	Typical	Max	Units
Input Compression Point	IP1dB	0.02 – 0.3 GHz 0.3 – 4.0 GHz	+13 +20	+24 +30		dBm dBm
3rd order input intercept point (+7 dBm tones, 1 MHz spacing)	IIP3	0.02 – 0.1 GHz 0.1 – 4.0 GHz	+22 +30	+35 +45		dBm dBm
2nd order input intercept point (+7 dBm tones, 1 MHz spacing)	IIP2	0.02 – 0.1 GHz 0.1 – 4.0 GHz	+28 +43	+65 +70		dBm dBm
Rise/Fall Time	t_{RISE}/t_{FALL}	10% RF rise/fall time		40	100	nS
ON/OFF Time	t_{ON}/t_{OFF}	50% V_{CTL} to 90%/10% RF		125	200	nS
Control Voltage High	V_{IH}	V_{DD} = 4.5 – 5.5 V	2.0		V_{DD}+0.5	V
Control Voltage Low	V_{IL}	V_{DD} = 4.5 – 5.5 V	-0.5		0.8	V
Digital Input Leakage	I_{IN}	V_{DD} = 4.5 – 5.5 V	-1		1	µA
Supply Current	I_{DD}	V_{DD} = 4.5 – 5.5 V			2	mA

1. All operating characteristics are guaranteed over full performance temperature range but not tested.

ABSOLUTE MAXIMUM RATINGS

Characteristic	Min.	Max.	Units
Supply voltage	-0.3	7.0	V
Control voltage	-0.5	V_{DD} + 0.5	V
RF Input power		+27	dBm
Operating temperature	-40	+85	˚C
Storage temperature	-65	150	˚C
Thermal resistance		400	˚C/W
ESD sensitivity (HBM)		500 (Class 1A)	V

1. Unit shall survive operation without damage over the temperature range but not tested.

Caution: Class 1A (HBM 500V) Electrostatic Sensitive Device. Proper ESD precaution should be used when handling device.

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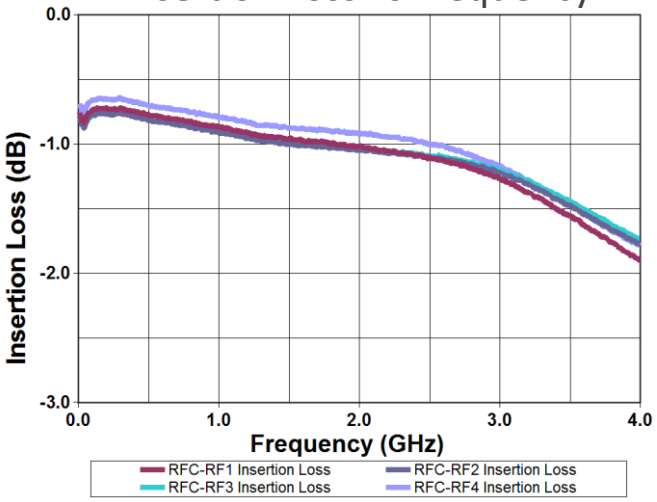
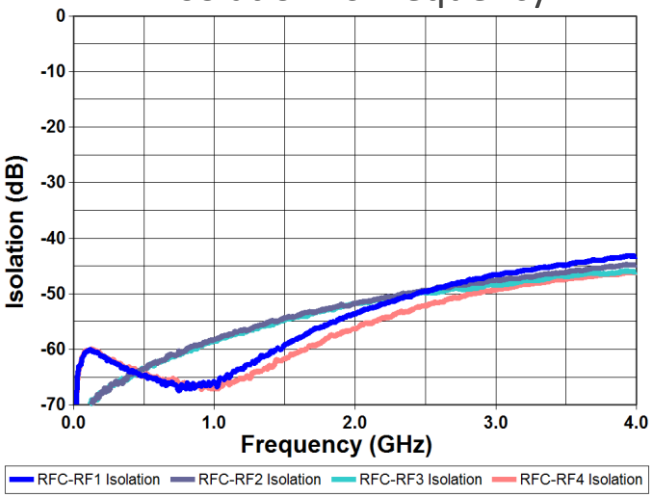
TYPICAL PERFORMANCE (+25 °C)

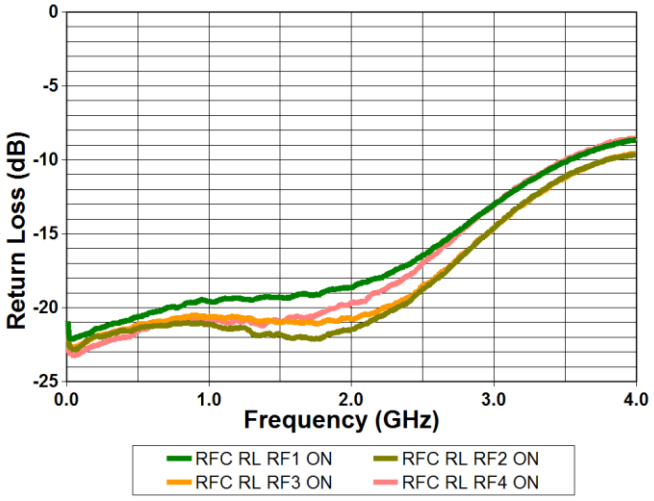
Insertion Loss vs Frequency



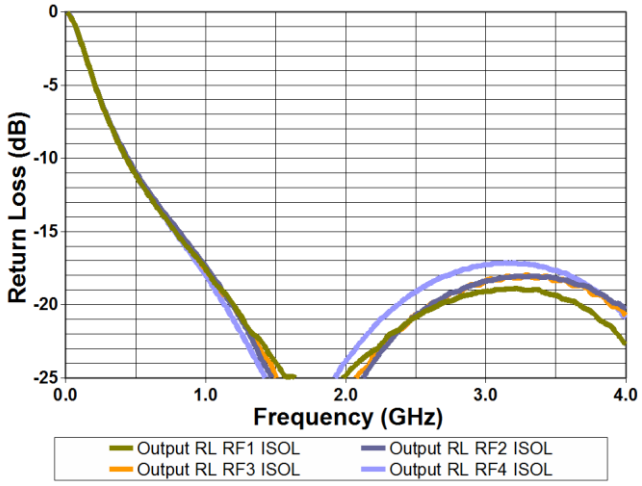
Isolation vs Frequency



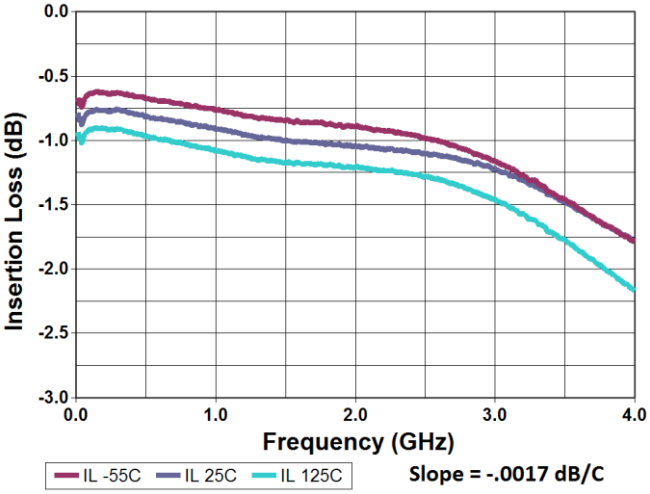
Input Return Loss vs Frequency



Output Return Loss vs Frequen-



Insertion Loss vs Temperature

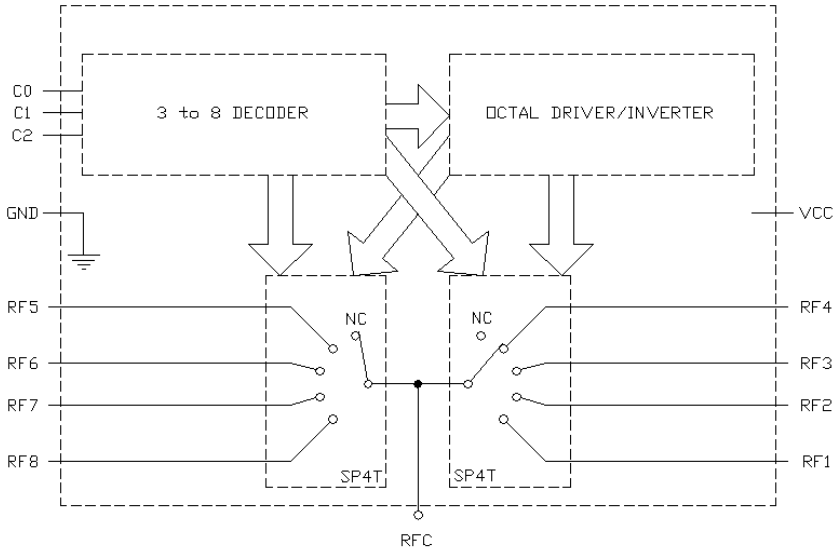


KS201 | Switch, SP8T

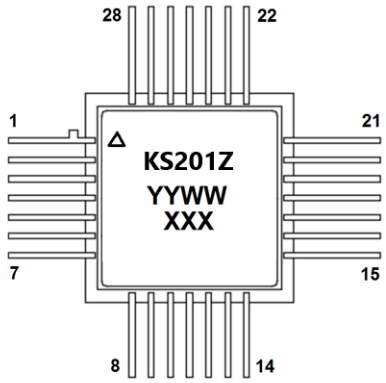
TRUTH TABLE

C0	C1	C2	RF Path
0	0	0	RFC—RF1
1	0	0	RFC—RF2
0	1	0	RFC—RF3
1	1	0	RFC—RF4
0	0	1	RFC—RF5
1	0	1	RFC—RF6
0	1	1	RFC—RF7
1	1	1	RFC—RF8

SCHEMATIC



DEVICE MARKING/PIN OUT:



- XXX = Serial # will be added for Class H and K Part #
- Z = Screening designation (C/H/K)

PIN	Designation	PIN	Designation
1	GND	15	GND
2	RF7	16	RF3
3	GND	17	GND
4	V_{CC}	18	GND
5	GND	19	GND
6	RF6	20	RF2
7	GND	21	GND
8	RF5	22	GND
9	GND	23	RF1
10	C0	24	GND
11	C1	25	RFC
12	C2	26	GND
13	GND	27	RF8
14	RF4	28	GND

PACKAGE NOTES:

- Lid/Leads: ASTM F-15 Alloy
- Base/Walls: Alumina
- Lid Finish: Nichel plate
- Leads/Seal Ring/Bottom: Gold over Nickel

ADDITIONAL NOTES:

- Maximum reflow temperature: 265°C
- Package base if RF ground
- External blocking capacitors required on all RF ports
- CARE SHOULD BE TAKEN WHEN SELECTING PCB MATERIAL AND ASSEMBLY METHODS TO MINIMIZE CTE MISMATCH WITH PACKAGE.

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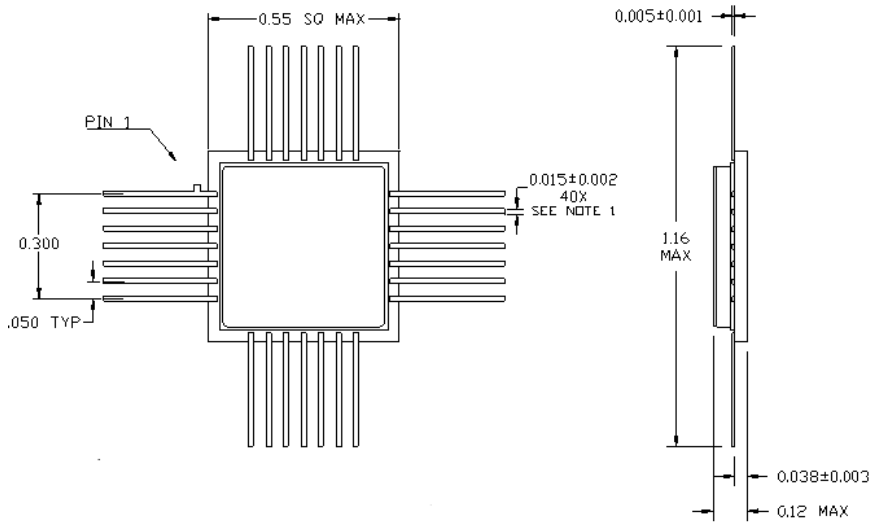
OUTLINE:



SCREENING FLOW:

Test Inspection	MIL – STD -883		Requirement	
	Method	Condition	Class H	Class K
Element Evaluation	MIL-PRF-38534	Table C-1	Per Table	Per Table
Non-Destructive Bond Pull	2023		Process under SPC	100%
Internal Visual	2010	B= Class H, A = Class K	100%	100%
Temperature Cycle	1010	C, 10 Cycles	100%	100%
Acceleration	2001	B (Y1 only)	100%	100%
PIND	2020	A (5 Cycles)	N/A	100%
Serialization	Per Product Specification		100%	100%
Radiographic	2012	2 views	N/A	100%
Electrical Test	Per Product Specification	+25°C	100%	100%
Burn In	1015	A	100%/160 Hrs/125°C	100%/320 Hrs/125°C
Final Electrical	Per Product Specification	+25°C	100%	100%
PDA Calculation	1015	25% Δ IL / 100% Δ I_{CC}	10%	2% Interim to Post
Group A Electrical	Per Product Specification	-40°C and + 85°C	45/0	45/0
Seal: Fine Leak Gross Leak	1014	A C	100%	100%
External Visual	2009		100%	100%

Notes:

1. Product under configuration control per KCB QAP 015.
2. Customer will be notified of all class 1 changes for Class H and K part numbers.
4. Electrical Test Data will be recorded for each serial number and included in Final Test Report for all Class K part numbers.
5. Group A Electrical testing will include the Small Signal at the Min/Max operating condition. The Dynamic test (P1dB, IP3, SS) will be tested at +25c only.

ORDERING INFORMATION:

	Unscreened	Class H	Class K
KCB Solutions Part Number	KS201C	KS201H	KS201K